

PATENT APPLICATION

M. Whetts 11/26/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

November 20, 2002

In re the Application of

Makoto KOBAYASHI et al.

Application No.: 09/830,434

Filed: April 2

April 26, 2001

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POLISHING PAD AND POLISHING METHOD FOR SEMICONDUCTOR WAFER

Group Art Unit: 3723

Examiner:

H. Shakeri

No. 100252

Docket No.: 109352

PETITION FOR EXTENSION OF TIME UNDER 37 C.F.R. §1.136(a)
AND TRANSMITTAL OF FEE UNDER 37 C.F.R. §1.17

Director of the U.S. Patent and Trademark Office Washington, D.C. 20231

Sir:

For:

Transmitted herewith is a Continuing Application based on the above-identified patent application. The shortened statutory period for response having expired on October 26, 2002, an extension of time for a period of one month is hereby requested. Attached hereto is our Check No. 136398 in the amount of \$110 pursuant to 37 CFR \$1.17.

The Director is hereby authorized to charge any additional fee (or credit any overpayment) associated with this communication to Deposit Account No. 15-0461. Two copies of this petition are enclosed.

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Respectfully submitted,

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